



BAW56W **DUAL SURFACE MOUNT SWITCHING DIODE**

Features

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Notes 2 and 3)

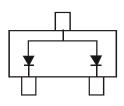
Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)



SOT323

Top View



Top View Internal Schematic

Ordering Information (Notes 3 & 4)

Part Number	Qualification	Case	Packaging
BAW56W-7-F	Commercial	SOT323	3000/Tape & Reel
BAW56WQ-7-F	Automotive	SOT323	3000/Tape & Reel

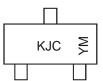
1. No purposefully added lead. Notes:

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date

Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants. 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



KJC = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Kev

Year	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	S	Т	U	V	W	Х	Y	Z	А	В	С	D	E
Month	Jan	Feb	Mar	Арг	· Ma	y Ji	ın	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	(6	7	8	9	0	Ν	D



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage		V _{R(RMS)}	53	V
Forward Continuous Current (Note 5)		I _{FM}	300	mA
Average Rectified Output Current (Note 5)		lo	150	mA
Non-Repetitive Peak Forward Surge Current (Note 5)	@ t = 1.0μs @ t = 1.0s	IFSM	2.0 1.0	А

Thermal Characteristics

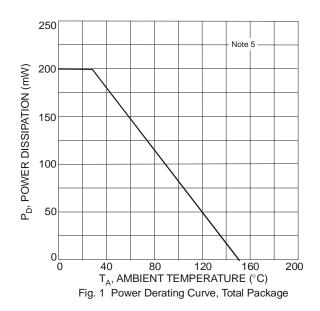
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{θJA}	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	D°

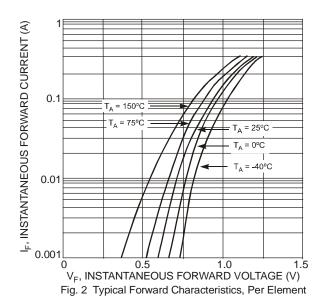
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	75	_	V	I _R = 2.5μA
Forward Voltage	VF	_	0.715 0.855 1.0 1.25	V	$I_{F} = 1.0mA$ $I_{F} = 10mA$ $I_{F} = 50mA$ $I_{F} = 150mA$
Reverse Current (Note 6)	I _R	_	2.5 50 30 25	μΑ μΑ μΑ nA	$V_{R} = 75V V_{R} = 75V, T_{J} = 150^{\circ}C V_{R} = 25V, T_{J} = 150^{\circ}C V_{R} = 20V$
Total Capacitance	CT	_	2.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

Notes:

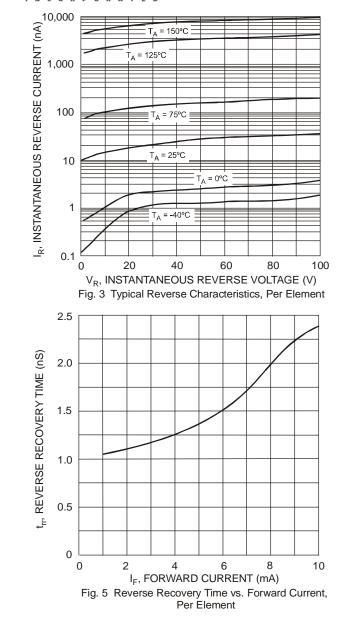
5. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.
6. Short duration pulse test used to minimize self-heating effect.











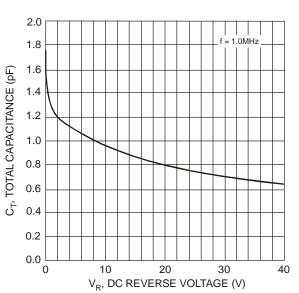
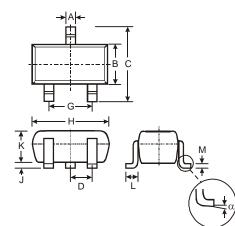


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

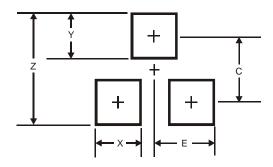
Package Outline Dimensions



	SOT323						
Dim	Min	Max	Тур				
Α	0.25	0.40	0.30				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	-	-	0.65				
G	1.20	1.40	1.30				
н	1.80	2.20	2.15				
J	0.0	0.10	0.05				
K	0.90	1.00	1.00				
L	0.25	0.40	0.30				
М	0.10	0.18	0.11				
α	0°	8°	-				
All	All Dimensions in mm						



Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0

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 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

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